



MILITARY / AEROSPACE DESIGN/PROCESS CHANGE NOTIFICATION

PCN Nr: MA98027

Issued: 12/15/98

GIDEP Nr: AH6-C-99-04	GIDEP Category: PCN	TRB Nr: 117 & 145
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This is to advise you that a Design and/or Process Change will be made to the following MIL/AERO product(s):

Product ID (Description):

ALL National Military Packaged Products.

Proposed Date of Change:

December 1998 (Datecode 9849 onward)

Description of Change:

National Semiconductor has defined and invoked package family groupings for Group D QCI testing (MIL-STD-883 Method 5005) for all military packaged products.

Under the guidelines of MIL-PRF-38535 QML process reduction procedures, National Semiconductor's Technology Review Board has reviewed and approved this process modification.

Effect of Change:

There will be no effect on product form, fit, function, or quality. Device attributes summaries will reflect this change as it is implemented.

In Case of further questions please contact:

	North America	Europe
QA / Spec Control	Tel: 408-721-5649	Tel: +49 (0)8141 35-1483 / 1402
PCN Administrator	Tel: 408-721-4189 Email: sherry.dobbins@nsc.com	Eur Mil Aero Marketing: Tel: +49 (0)8141 35 1495 Email: petra.pavel@nsc.com
Customer Support Center	Tel: 1-800-272-9959 Email: support@nsc.com	Tel: +49 (0)180 530 8585 (German) Tel: +49 (0)180 532 7832 (English) Email: europe.support@nsc.com
Other contacts	Rita Scherbakovsky, QA & R Eng (408) 721-4423 email: rita.scherbakovsky@nsc.com	

Other Ref:

Associated Notes / Table(s):